

Vishay Siliconix

N- and P-Channel 60-V (D-S) MOSFET

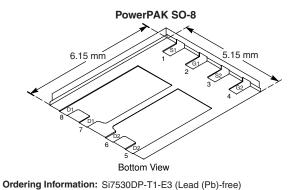
PRODUCT SUMMARY							
	$V_{DS}(V)$	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)			
N-Ch	60	0.075 at V _{GS} = 10 V	4.6	12 nC			
		0.100 at V _{GS} = 4.5 V	4.0	12110			
P-Ch	- 60	0.064 at V_{GS} = - 10 V	- 5.0	47			
		0.080 at V _{GS} = - 4.5 V	- 4.5	47			



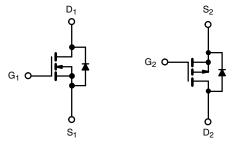
- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile
- 100 % R_q Tested







Si7530DP-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

P-Channel MOSFET

			N-Channel		P-Channel		Unit	
Parameter	Symbol	10 s	Steady	10 s	Steady			
Drain-Source Voltage		V _{DS}	60 - 60			60	v	
Gate-Source Voltage		V _{GS}		± 2	20			
Continuous Drain Current (T ₁ = 150 °C) ^a	T _A = 25°C	1-	4.6	3.0	- 5.0	- 3.2		
Continuous Drain Current $(T_J = 150^{\circ} C)^{\circ}$	$T_A = 70^{\circ}C$ I_D	3.6	2.4	- 4.0	- 2.6			
Pulsed Drain Current		I _{DM}	15		- 25		Α	
Continuous Source Current (Diode Conduction) ^a		ا _S	2.7	1.2	- 2.9	- 1.2	1	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	15		- 22			
Single Pulse Repetitive Avalanche Energy ^b		E _{AS}	11		24.2		mJ	
	$T_{A} = 25^{\circ}C$ $T_{A} = 70^{\circ}C$	· Po	3.3	1.4	3.5	1.5	- w	
Maximum Power Dissipation ^a			2.1	0.9	2.2	0.94		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150				°C		
Soldering Recommendations (Peak Tempera	Ť	260						

THERMAL RESISTANCE RATINGS

			N-Ch	annel	P-Ch	Unit		
Parameter		Symbol	Typical	Maximum	Typical	Maximum	onn	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	29	38	27	36		
Maximum Junction-to-Ambient*	Steady State	' 'thJA	60	85	60	85	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	4.0	5.2	3.3	4.3		

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Duty Cycle \leq 1 %.

c. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Unit	
Static						1		
		$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	N-Ch	1		3		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	P-Ch	- 1		- 3	V	
Cata Pady Laskaga	1	$V_{-1} = 0 V V_{-1} = \pm 20 V$	N-Ch			± 100	nA	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	P-Ch			± 100		
		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1		
Zero Gate Voltage Drain Current	1	$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	P-Ch			- 1	μΑ	
Zero Gale Vollage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$	N-Ch			5	1 μΑ	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$	P-Ch			- 5		
On-State Drain Current ^a		$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	N-Ch	15			А	
	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 10 V	P-Ch	- 25				
		V _{GS} = 10 V, I _D = 4.6 A	N-Ch		0.060	0.075	- Ω	
		V _{GS} = - 10 V, I _D = - 5.0 A	P-Ch		0.051	0.064		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 4.0 A	N-Ch		0.080	0.100		
		V _{GS} = - 4.5 V, I _D = - 4.5 A	P-Ch		0.064	0.080		
Forward Transconductance ^a		V _{DS} = 15 V, I _D = 4.6 A	N-Ch		6			
	9 _{fs}	V _{DS} = - 15 V, I _D = - 5.0 A	P-Ch		16		S	
		I _S = 2.7 A, V _{GS} = 0 V	N-Ch		0.85	1.2		
Diode Forward Voltage ^a	V_{SD}	I _S = - 2.9 A, V _{GS} = 0 V	P-Ch		- 0.85	- 1.2	V	
Dynamic ^b	L				•	I		
-	Qg	N-Channel	N-Ch		12	20	nC	
Total Gate Charge			P-Ch		26	40		
Gate-Source Charge	0	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 15 \text{ A}$	N-Ch		2			
Gale-Source Charge	Q _{gs}	P-Channel	P-Ch		4.5			
Gate-Drain Charge	Q _{gd}	V_{DS} = - 30 V, V_{GS} = - 10 V, I_{D} = - 5.0 A	N-Ch		3.5			
			P-Ch		7		<u> </u>	
Gate Resistance	R _g	f = 1.0 MHz	N-Ch	0.6	1.5	2.5	Ω	
			P-Ch N-Ch	3.5	7	11		
Turn-On Delay Time	t _{d(on)}	N-Channel	P-Ch		8	15 15		
		$\begin{split} V_{DD} &= 30 \text{ V}, \text{R}_{\text{L}} = 30 \ \Omega \\ \text{I}_{\text{D}} &\cong 1 \text{A}, \text{V}_{\text{GEN}} = 10 \text{V}, \text{R}_{\text{g}} = 6 \ \Omega \end{split}$	N-Ch		8	15	1	
Rise Time			P-Ch		9	15		
	t _{d(off)}	P Channel	N-Ch		15	25	ns	
Turn-Off Delay Time		P-Channel V_{DD} = - 30 V, R _L = 30 Ω	P-Ch		65	100		
Fall Time	t _f	$I_D \cong -1 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 6 \Omega$	N-Ch		7	20		
	Ч		P-Ch		30	45		
Source-Drain Reverse Recovery Time	tu	$I_F = 2.7 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}$	N-Ch		30	60		
	e t _{rr}	I _F = - 5 A, dl/dt = 100 A/μs	P-Ch		40	80		
Reverse Recovery Energy	nergy Q _{rr}	I _F = 2.7 A, dl/dt = 100 A/μs	N-Ch		33	66	рС	
Reverse Recovery Energy		I _F = - 5 A, dl/dt = 100 A/μs	P-Ch		57	115		

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

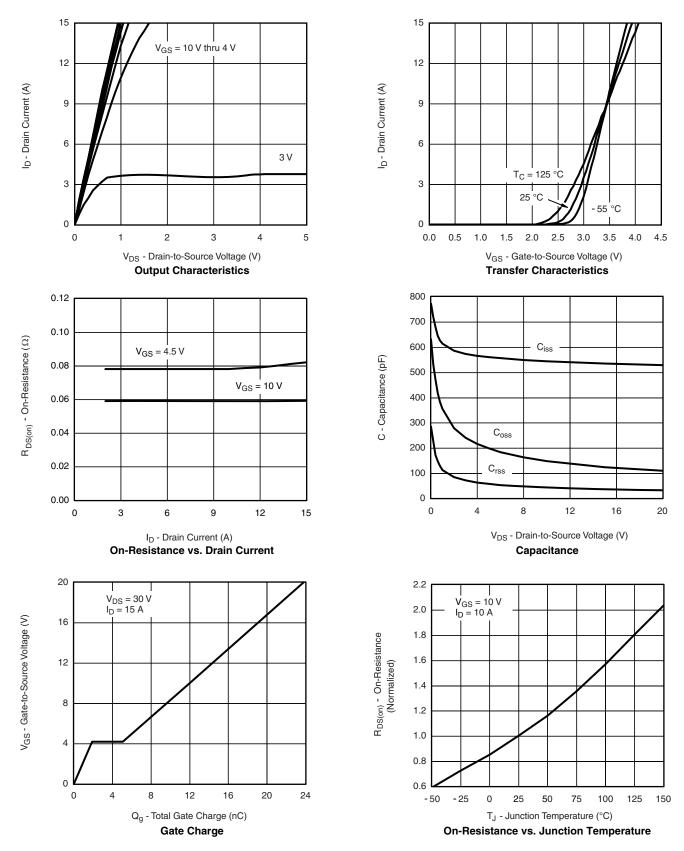
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Si7530DP

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N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

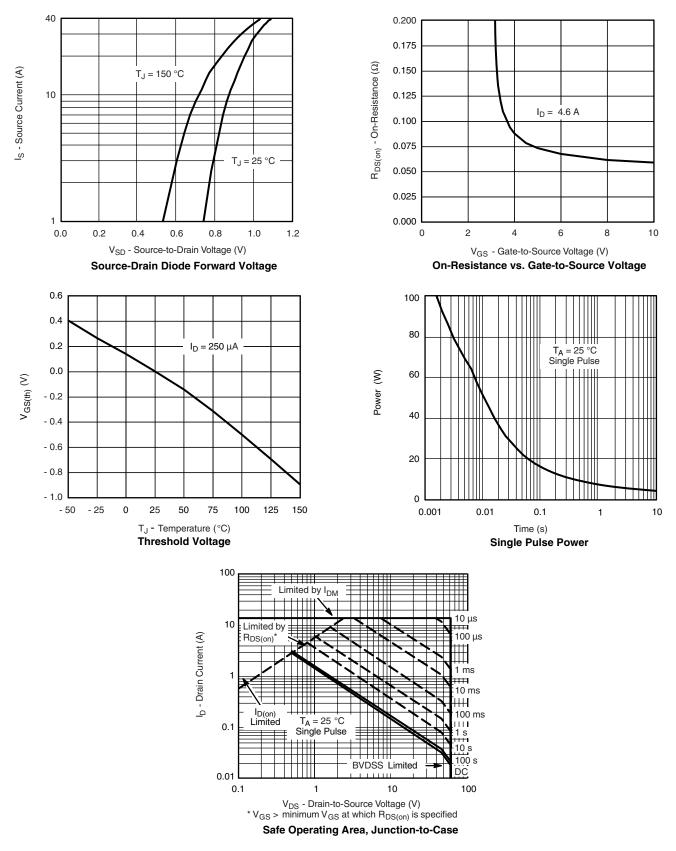


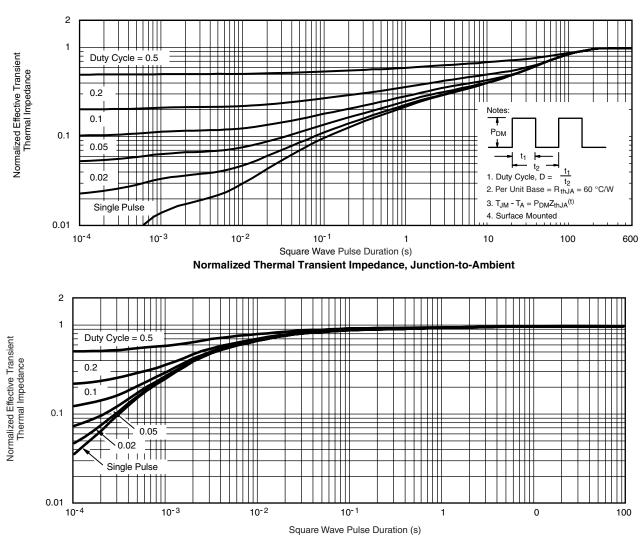
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Si7530DP

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N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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Normalized Thermal Transient Impedance, Junction-to-Case

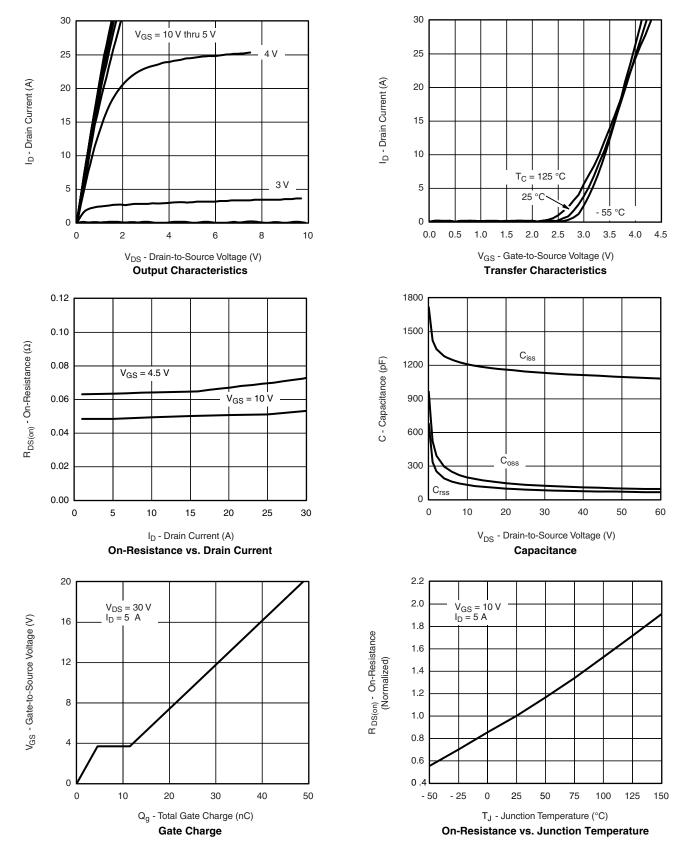
Si7530DP

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Si7530DP

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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

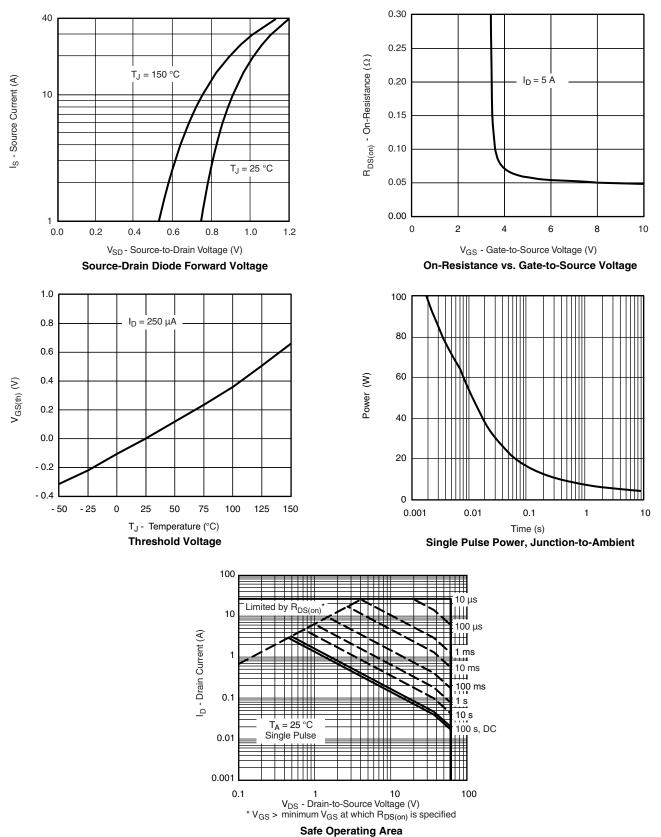




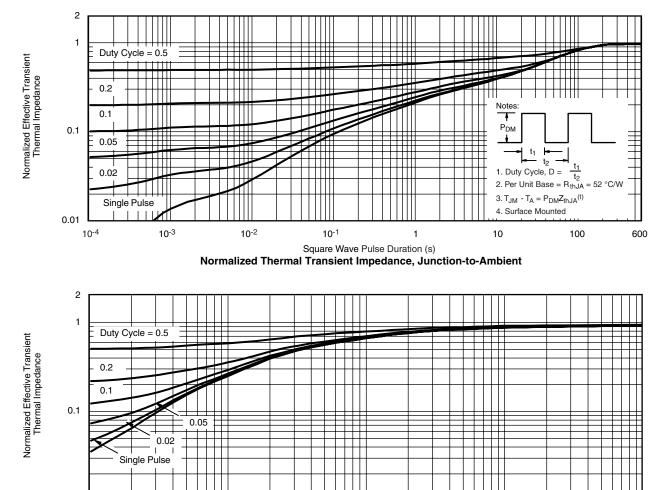


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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

10⁻³

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Case

10⁻²

10-1

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73249.

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